#### IEC 62319-1 (First edition – 2005)

#### Polymeric thermistors – Directly heated positive step function temperature coefficient –

Part 1: Generic specification

# **CORRIGENDUM 1**

## 2.3.2 Bump test severities

Replace the title and the entire paragraph by the following entry:

2.3.2

Void

### 2.3.4 Vibration severities

Replace, in the fourth paragraph, "98 m/s<sup>2</sup>" by "100 m/s<sup>2</sup>".

## 3.5.7.2 Assessment level

Replace in Table 2, third column, "3)" by "c".

## 4.8.1 Solderability

*Replace, in the first sentence,* "The thermistors shall be subjected to Test Ta of IEC 60068-2-20..." *by* "The thermistors shall be subjected to Test Tb of IEC 60068-2-20...".

## 4.11.2 Dry heat

*Replace, in the first sentence,* "The thermistors shall be subjected to the procedure of Test Ba of IEC 60068-2-2..." by "The thermistors shall be subjected to the procedure of Test Bd of IEC 60068-2-2...".

## Annex A Fixed sample size test schedules for qualification approval

Replace the numbering of item d) as follows:

Instead of "D" insert "d)".